

100V_{DS} N-Channel Enhancement Mode MOSFET

Features

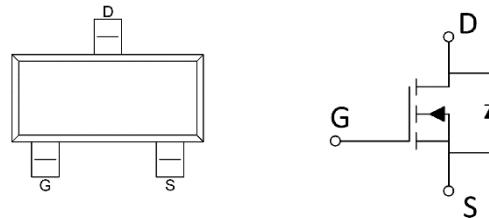
SOT23

- $V_{DS}=100V, I_D=2A$
- $R_{DS(ON)}=234m\Omega$ (TYP.) $V_{GS}=10V$
- Reliable and Rugged
- Avalanche Rated
- Low On-Resistance



Applications

- Load Switch
- Power management in portable/desktop PCs
- DC/DC conversion



Ordering Information

Device	Package		Marking	Package Qty.
HMN2324	SOT-23	Pb-Free	S24	3000pcs/Reel

Absolute Maximum Ratings ($T_C=25^\circ C$, unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage ($V_{GS}=0V$)	V_{DS}	100	V
Gate-Source Voltage ($V_{GS}=0V$, static)	V_{GS}	± 20	V
Continuous Drain Current ($T_C=25^\circ C$)	I_D	2	A
Continuous Drain Current ($T_C=100^\circ C$)		0.62	A
Maximum Power Dissipation ($T_C=25^\circ C$)	P_D	0.35	W
Operating, Storage Temperature Range	T_J, T_{STG}	-55~150	°C

Thermal Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit
Thermal Resistance,Junction-to-Case	R _{θJC}	-	60	-	°C / W
Thermal Resistance,Junction-to-Ambient	R _{θJA}	-	375	-	°C / W

Electrical Characteristics

Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V,I _D =250μA	100	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =24V, V _{GS} =0V	-	-	1	μA
Gate -Source Leakage Current	I _{GSS}	V _{GS} =±12V, V _{DS} =0V	-	-	±100	nA
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} ,I _D =250μA	1.2	-	2.8	V
Drain-Source On-stage Resistance	R _{DS(ON)}	V _{GS} =10V,I _D =2.8A	-	195	248	mΩ
		V _{GS} =4.5V,I _D =2.5A	-	200	266	

Dynamic Characteristics

Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Input capacitance	C _{iss}	V _{DS} =15V V _{GS} =0V f=1MHz	-	305	-	pF
Output capacitance	C _{oss}		-	65	-	
Reverse transfer capacitance	C _{rss}		-	29	-	
Total Gate Charge	Q _g	V _{DS} =15V V _{GS} =4.5V I _D =5.8A	-	-	5.8	nC
Gate Source Charge	Q _{gs}		-	0.75	-	
Gate Drain Charge	Q _{gd}		-	1.4	-	
Turn-on delay Time	t _{d(on)}	V _{GS} =10V V _{DS} =15V R _L =2.7Ω R _G =3Ω	-	-	45	ns
Rise time	t _r		-	-	39	
Turn-off delay Time	t _{d(off)}		-	-	26	
Fall time	t _f		-	-	20	

Reverse Diode Characteristics

Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Body Diode Forward Voltage	V _{SD}	V _{GS} =0V,I _{SD} =1A	-	0.8	1.2	V
Reverse Recovery Time	t _{rr}	V _{GS} =0V,I _{SD} =5A	-	16	-	ns
Reverse Recovery Charge	Q _{rr}	d _i /d _t =100A/μs	-	9	-	nC

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